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AZ DISPLAYS

SPECIFICATIONS FOR LIQUID CRYSTAL DISPLAY

	CUSTOMER APP	ROVAL	
X PART NO.	: ATM0350D2 (AZ DISP	LAYS) VER2.2	
APPROVAL		COMPANY CHOP	
CUSTOMER			
COMMENTS			

AZ DISPLAYS ENGINEERING APPROVAL										
DESIGNED BY	CHECKED BY	APPROVED BY								

REVISION RECORD

REVISION	REVISION DATE	PAGE	CONTENTS
VER1.0	2008-07-10		FIRST ISSUE
VER2.0	2011-08-22		UPDAT E LCD
VER2.1	2013-04-12	8	MODIFY OPTICAL CHARACTERISTICS
VER2.2	2013-05-02	4,5	UPDATE VIEWING ANGLE INFORMATION

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1 LCD MODULE PHYSICAL DATA

1.1 General Description

Display Type	TFT/Transmissive
Connection Type	COG + FPC
Operation temperature	-20°C ~70°C
Storage temperature	-30°C ~80°C
Driving IC	HX8238-D
MPU interface	RGB interface

Table 1.

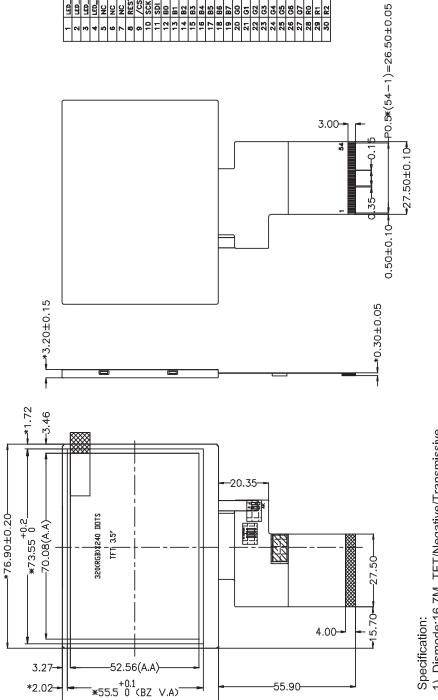
1.2 <u>Mechanical Description</u>

Item	Standard Value	Unit
Screen size	3.5	inch
Number of dots	320RGB x 240 dots	-
LCM dimension	76.90(W) x 63.90(H) x 3.20(T)	mm
Active area	70.08(W) x 52.56H)	mm
Dot size	0.219(W) x 0.219(H)	mm
Approx. weight	TBD	g
Backlight	6 chip white LED in series	

Table 2.

2 **OUTLINE DIMENSIONS**

1 R3	2 R4	33 R5	-	5 R7	36 HSYNC	7 VSYNC	8 DOTCLK		40 NC	1 VDD		NC N2	P V V V	L5 NC	4B NC	17 NC	48 NC(XR)	49 NC(YD)	50 NC(XL)	51 NC(YU)	2 ENB	53 GND	4 GND					
LED_Cathode 3	LED_Cathode 3.	LED_Anode 3		NC	NC		RESTET 3		SCK 4	spi 4	4	81 4	B2 4	83 4	B4 4		BG 4.		200	G1 5	G2 5.	G3 G3	G4 5	65	C6	 RO	R1	R2
-		2		5	2 9	7	8	6	10 \$	11	12 E	13 8	-	-	16 E	-	18 E	19 E	20			23 0		25 0		28 F		30 6



*63.90±0.20

1). Dismode: 16.7M, TFT/Negative/Transmissive

2) Operation temp: -20 $^{\circ}C \sim +70 ^{\circ}C$

Storage temp: -30 °C~+80 °C

3) IC: HX8238-D

Backlight : 6 chip White LED in Series
 Dimensions with mark "*" are important, with mark "()" are referen

3 BLOCK DIAGRAM

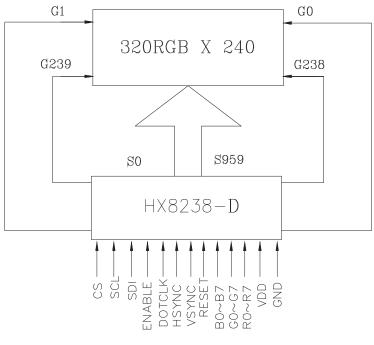


Figure 2.

4 ABSOLUTE MAXIMUM RATINGS

ITEM	SYMBOL	CONDITION	STA	STANDARD VALUE			
	5111202	CONDITION	MIN	TYP	MAX	UNIT	
Power Supply Voltage(1)	VDD	Ta=+25℃	-0.3	-	4.6	V	
Power Supply Voltage(2)	Iovcc	Ta=+25℃	-0.3	-	4.6	V	
Power Supply Voltage(3)	Vci	Ta=+25℃	-0.3	-	4.6	V	
Input Voltage	Vin	Ta=+25 ℃	-0.3	-	Vcc+0.3	V	
Operating Temperature	Тор		- 20	-	+70	°C	
Storage Temperature	Tst		- 30	-	+80	°C	

Table 3.

NOTE:

(1). If the module is used above these absolute maximum ratings. It may become permanently damaged. Using the module within the following electrical characteristic conditions are also exceeded, the module will malfunction and cause poor reliability

(2). LCM should be grounded during handing LCM.

(3). VDD>GND must be maintained.

5 ELECTRICAL CHARACTERISTICS

5.1 DC Characteristics

ITEM	SYMBOL	MBOL CONDITION STANDARD V			VALUE	UNIT	
		S	MIN	TYP	MAX		
Power Supply Voltage for Logic	VCI	Ta=+25℃	2.8	3.0	3.3	V	
Power Supply Voltage for I/O circuit	VDDIO	Ta=+25℃	1.8	3.0	3.3		
Input High Voltage for LCD	VIH	—	0.8Iovcc	_	Iovcc	V	
Input Low Voltage for LCD	VIL	_	Vss	_	0.2 Iovcc	V	
Output High Voltage for LCD	VOH	—	0.8Iovcc	_	Iovcc	V	
Output Low Voltage for LCD	VOL	_	Vss	_	0.2 Iovcc	V	

Table 4.

5.2 Back-Light unit

PARAMETER	SYMBOL	REMARK	STANI	DARD V	ALUE	UNIT	
			MIN	TYP	MAX		
FORWARD VOLTAGE	VF	If=20mA	18.0	19.2	20.4	V	
LUMINOUS INTENSITY(INCLUDE LCD)	Iv	If=20mA	380	400	-	cd/m2	
LUMINOUS TOLERANCE	Iv-m	(min/max)/100	-	80	-	%	
CHROMATICITY	Х	If=20mA	0.270		0.310		
COORDINATES(INCLUDE LCD)	Y	11–20111A	0.290		0.330		
OPERATING TEMPERATURE	-20°C ~ 70°C						
STORAGE TEMPERATURE		-30	°C ~ 80°C				

Table 5.

5.3 AC Characteristics

Refer to $HX8238\mbox{-}D$ data sheet.

6 ELECTRO-OPTICAL CHARACTERISTICS

Para	mete	Symbol	Condition	Min	Тур	Max	Unit	Remark
Threshold vo	oltage	Vsat		2.7	3.3	3.8	V	Note 1
	-	Vth		1.2	1.5	1.8	V	Note 1
	Horizontal	Left(9')		70	75	-	Deg	
Viewing Angle	Horizontai	Right(3')	- CR > 10	70	75	-	Deg	Not 2
range	X7 / 1	Up(12')		50	55	-	Deg	NOL 2
	Vertical	Down(6')		55	60	-	Deg	
Contra	st ratio	C/R	$\Theta = 0^{\circ}$	-	300	-		Not 3
Transmittance		T(%)	$\Theta = 0^{\circ}$	-	7.4	-		Not 4
Respon	se Time	Tr+Tf	$\Theta = 0^{\circ}$		30		msec	Not 6

Table 6.

Note :

1. The definition of Vth & Vsat

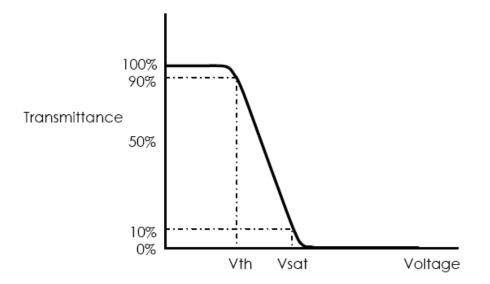


Figure 3. The definition of Vth & Vsat

2.Viewing angle is the angle at which the contrast ratio is greater than 10. The viewing are determined for the horizontal or 3, 9 o'clock direction and the vertical or 6, 12 o'clock direction with respect to the optical axis which is normal to the LCD surface.

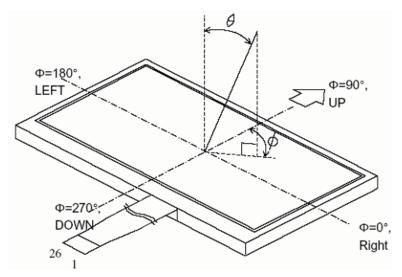


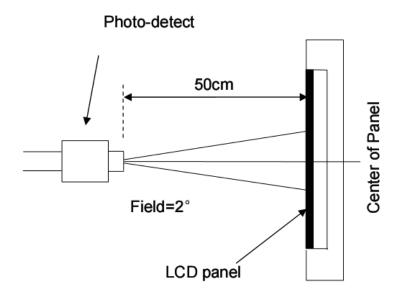
Figure 4.Definition of viewing angle

3. Contrast measurements shall be made at viewing angle of $\Theta = 0^{\circ}$ and at the center of the LCD surface. Luminance shall be measured with all pixels in the view field set first to white, then to the dark (black) state.

$CR = \frac{Luminance when displaying a white raster}{Luminance when displaying a black raster}$

4. Transmittance is the value with Polarizer.

5. The color chromaticity coordinates specified in Table 6. shall be calculated from the spectral data measured with all pixels first in red, green, blue and white. Measurements shall be made at the center of the C/F. Measurement condition is C - light source & Halogen Lamp.





6. The electro-optical response time measurements shall be made as FIGURE 3 shown in Appendix by switching the "data" input signal ON and OFF. The times needed for the luminance to change from 10% to 90% is Tr, and 90% to 10% is Td

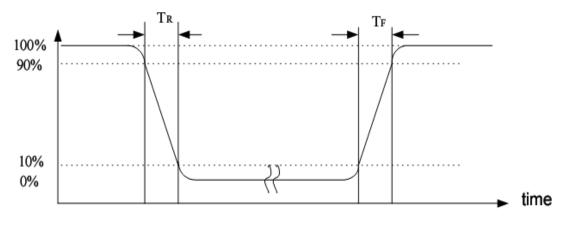


Figure 6.Definition of response time: Tr+Tf

7 SIGNAL TIMING DIAGRAM

7.1 **DC** Characteris

DC Characteristics

(Unless otherwise specified, Voltage Referenced to Vss, Vppo = 2.2V, TA = 25°C)

Symbol	Parame)er	Test condition		Spec.	683	Unit	
aymoor	Paraniteter	rescondition	Min.	Тур.	Max.	onne	
Voo	System power supply pins of the logic block	Recommend Operating Voltage Possible Operating Voltage	1.6	1.5	2.50	v	
Vocio	Power supply pin of IO pins	Recommend Operating Voltage Possible Operating Voltage	1.6	~ .	3.6	٧	
Voi	Booster Reference Supply Voltage Range	Recommend Operating Voltage Possible Operating Voltage	2.5 or VDDIO	1	3.6	۷	
clees	Sleep mode current	-	AU	A 50	10 - 14	μA	
de	Operating mode current	VCI=3.3V		U/10	12	mA	
Volu	Negative V _{ol} Output Voltage	No panel loading	(YOK)		- VCI+0.7	V	
Vena	Voixe primary booster efficiency ⁽¹⁾	No panel loading, ITO for Voixa, Voi and Voisa = 10 Ohm		90	-	%	
		No panel loading; 4x booster; ITO for C _{YP} , C _{YN} , V _{CIX2} , V _d and V _{CIX5} = 10 Ohm	∑¥ <	89.5	-	%	
V _{GH}	Gate driver High Output Voltage Booster efficiency ⁽²⁾	No panel loading; 5x booster, ITO for Cyp, Cyn, Vooz, Vo, and Voys = 10 Ohm	80	88.5	-	96	
		No panel loading: 6x booster; ITO for Cyp, Cyb, Voxa, Voi and Voxa - 10 Ohm	SS.	80		%	
Vol	Gate driver Low Output Voltage	- (1) - (1) -	//-Vан	8	-5.1	V	
VCOMM	VCOM High Output Voltage	SOU IL	•		5.54	V	
VCOM	VCOM Low Output Voltage	(O) VI	V _{CIM} +0.5			V	
Vooma	VCOM Amplitude		1943-19 1 74-19		6	٧	
VLCOB	VLCDM Output Voltage	1 (3	3 .	6. sec.	5.57	V	
∆V _{LCDes}	Max. Source Voltage Variation 🔪	1 ~~~~	-2	-	2	%	
Vон	Logic High Output Voltage	lout = -100µA	0.9V00ю		Voo	V	
V _{VD}	Source Output Voltage Deviation	- ~~	Successive.	±20	G 94.5 S	mV	
Vos	Source Output Voltage Offset	A			±30	mV	
VOLT	Logic Low Output Voltage	Tout = 100uA	0		0.1Vppto	V	
Ven	Logic High Input voltage	- \\	0.8V _{ppio}		Vocio	V	
Villa	Logic Low Input voltage		0	8	0.2Vppto	V	
lon	Logic High Output Current Source	V out = VDD - 0.4V	50			UA.	
lou	Logic Low Output Current Drain	N out = 0.4V		1	-50	μA	
loz	Logic Output Tri-state Current Drain Source	-	-1	1973	1	μΑ	
han 🔿	Lógic Inpút Current	-	-1	-	1	μA	
C _N	Logic Pins Input Capacitarice	-	-	5	7.5	pF	
Rson	Source drivers output resistance	-	3 - 31	1	-	kΩ	
Rean	Gate drivers output resistance	-	-3	500	3.2	Ω	
Roon	VCOM output resistance	-	-	200	SS 52 - 3	Ω	

Note : (1) VCIX2 efficiency = VCIX2 / (2 x VCI) x 100% (2) VGH efficiency = VGH / (VCI x n) x 100% (where n = booster factor)

Figure 7. DC Characteris

7.2 AC Characteris

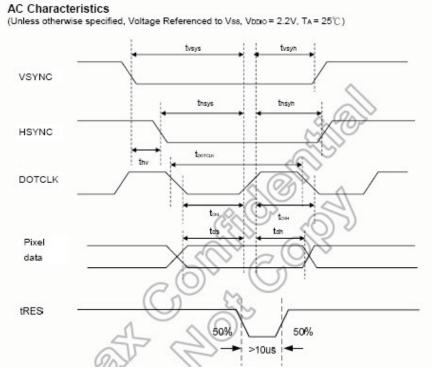


Figure 8. Pixel Timing

Characteristics	Symbol	Min.		Typ.		Max.		- Unit
characteristics		24 bit	8 bit	24 bit	8 bit	24 bit	8 bit	
DOTCLK Frequency	fDOTCLK		1000 m	6.5	19.5	10	30	MHz
DOTCLK Period	tDOTCLK	100	33.3	154	51.3		-	ns
Vertical Sync Setup Time	tvsys	20	10			-	-	ns
Vertical Sync Hold Time	tvsyh	20	10		-			ns
Horizontal Sync Setup Time	thsys	20	10	-	-	-	-	ns
Horizontal Sync Hold Time	thsyh	20	10	. S-S		-		ns
Phase difference of Sync Signal Falling Edge	thv	1				24	10	tDOTCLK
DOTCLK Low Period	tCKL	50	15		<u> </u>	2	1.2	ns
DOTCLK High Period	tCKH	50	15	-	-	-	-	ns
Data Setup Time	tds	12	10		-	•	-	ns
Data hold Time	tdh	12	10			121	2	ns
Reset pulse width	tRES	1	0	2 2		1	2	μS

Note: External clock source must be provided to DOTCLK pin of HX8238-D. The driver will not operate if absent of the clocking signal.

Figure 9. Pixel Timing

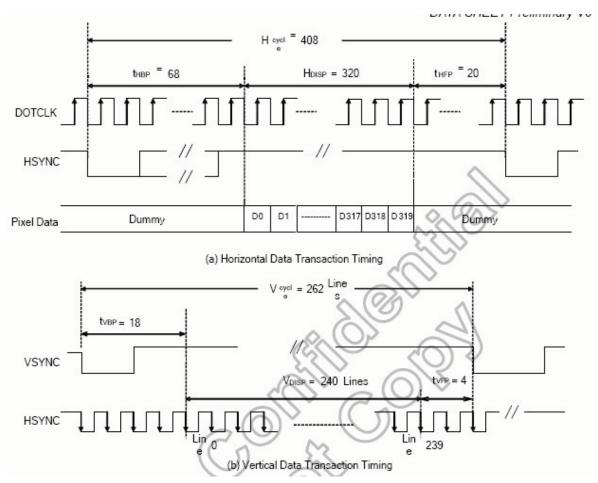


Figure 10. Data Transaction Timing in Parallel RGB (24 bits) SYNC MODE

Characteris	tice	Sumbol	Min.		Typ.		Max.		Unit
characteristics		Symbol	24 bit	8 bit	24 bit	8 bit	24 bit	8 bit	Unit
DOTCLK Frequence	SY AN	fDOTCLK	-		6.5	19.5	10	30	MHz
DOTCLK Period	AV	tDOTCLK)	100	33.3	154	51.3	-	-	ns
Horizontal Frequer	ncy (Line)	fH		8	14	.9	22	.35	KHz
Vertical Frequency	(Refresh)	<< fy)	-	8	6	0	9	0	Hz
Horizontal Back Po	orch	UHBP		-	68	204	1 -		tDOTCLK
Horizontal Front Po	orch	tHFP	-	-	20	60	-		tDOTCLK
Horizontal Data Sta	art Point	tHBP	-		68	204		<u> </u>	tDOTCLK
Horizontal Blanking Period		tHBP + tHFP	(+)	-	88	264	-) +)	tDOTCLK
Horizontal Display	Area	HDISP	-		320	960	-	-	tDOTCLK
Horizontal Cycle		Hcycle		-	408	1224	450	1350	tDOTCLK
Vertical Back Porch		tVBP	8 .		1	8	8	. 1	Lines
Vertical Front Porc	h	tVFP		â.	4	1		2	Lines
Vertical Data Start	Point	tVBP	9	ě.	1	8		2000	Lines
Vertical Blanking P	eriod	tVBP + tVFP	-	\$	2	2		-	Lines
Vertical Disalau	NTSC				24	10			
Vertical Display	PAL	VDISP	-		280(PALM=0) 288(PALM=1)				Lines
Area	PAL								
Vertical Cycle PAL		Vevelo	-		262		350		1.54.44
		Vcycle			31	3	- 3	50	Lines

Figure 11. Data Transaction Timing in Normal Operating MODE

7.3 **Power Up Sequence**

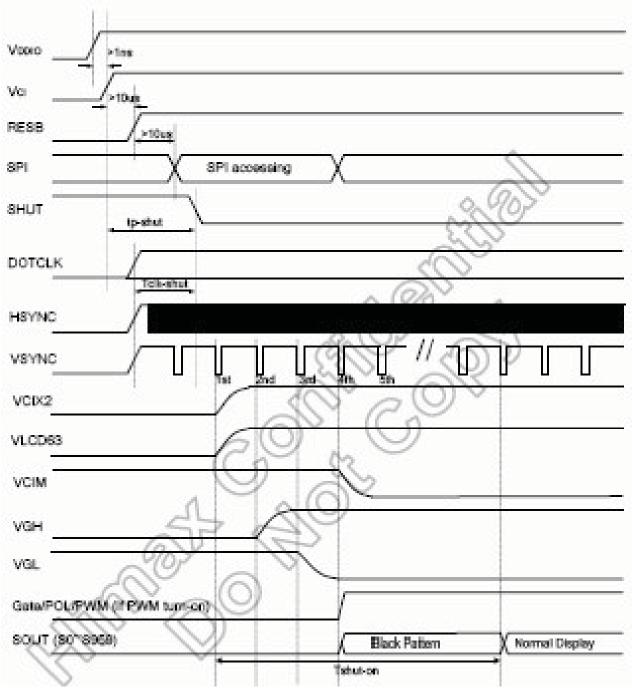


Figure 12. Power Up Sequence

7.4 **Power Up Sequence**

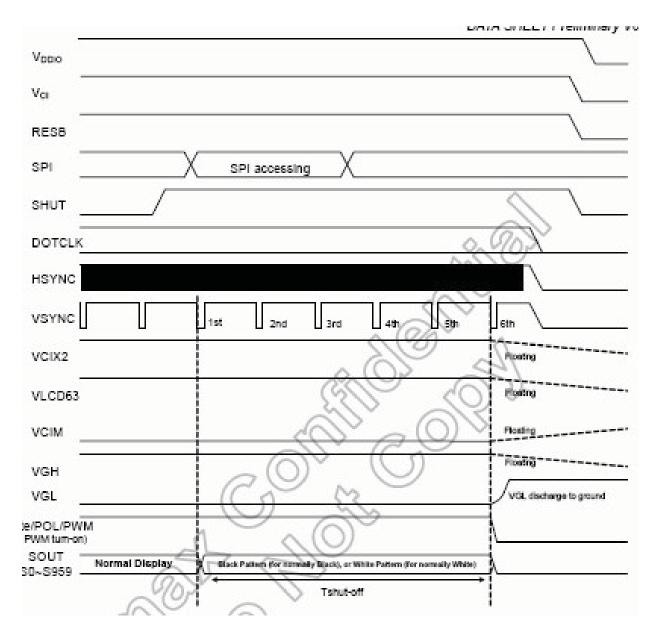


Figure 13. Power Down Sequence

8 INTERFACE PIN CONNECTIONS

PIN NO.	SYMBOL	FUNCTION DESCRIPTIONS		
1~2	LED-	The backlight ground		
3~4	LED+	Power supply for backlight		
5~7	NC	No connection		
8	RESET	LCD Reset signal		
9	CS	Chip select		
10	SCL	Clock synchronization signal		
11	SDI	SPI serial signal		
12~19	B0~B7	B signal Data bus		
20~27	G0~G7	G signal Data bus		
28~35	R0~R7	R signal Data bus		
36	HSYNC	Line synchronization signal		
37	VSYNC	Frame synchronization signal		
38	DOTCLK	DOT synchronization signal		
39~40	NC	No connection		
41~42	VDD	Power supply for logic circuit		
43~47	NC	No connection		
78	XR			
49	YD	Touch panel select pin(No connection)		
50	XL			
51	YU			
52	ENB	A data ENABLE signal in RGB I/F mod		
53~54	GND	Ground		

Table 6.

9 INITIALIZED CODE

Please contact us for details.

10 SPECIFICATION OF QUALITY ASSURANCE

10.1 Summary

The customer should check and accept the products of ZET within one month after reception.

This standard for Quality Assurance should affirm the quality of LCD products to supply to purchaser by ZET COMPANY LIMITED. Entire process is controlled according to QS9000.

10.2 Standard for quality test

(1) Inspection

Before delivering, the supplier should take the following tests, and affirm the quality of product.

(2) Electro-Optical Characteristics

According to the individual specification to test the product.

(3) Test of Appearance Characteristics:

According to the individual specification to test the product.

(4)Test of Reliability Characteristics

According to the definition of reliability on specification for test product.

(5) Delivery Test

Before delivering, the supplier should take the delivery test

- (6)Sampling Method: GB/T2828.1-2003, Level II
- (7) The defects classify of AQL as following

Major defect: AQL=0.65

Minor defect: AQL=1.5

10.3 Nonconforming Analysis & Deal With Manners

☆Nonconforming Analysis

(1) Purchaser should supply the detail data of nonconforming sample and the non-suitable state.

(2) After accepting the detail data from purchaser ,the analysis of nonconforming should be finished in two weeks.

(3) If supplier can not finish analysis on time ,must announce purchaser before two weeks.

 \gtrsim Disposition of nonconforming

(1) If find any supplier defect during assembly line, supplier must change the good product for every defect after recognition.

(2) Both supplier and customer should analysis the reason and discuss the disposition of nonconforming when the reason of nonconforming is not sure.

10.4 Agreement items.

Both sides should discuss together when the following problems happen:

(1) There is any problem of standard of quality assurance ,and both sides think that must be modifier.

(2) There is any argument item which does not record in the quality assurance.

(3) Any other special problem.

10.5 Standard of the Product Appearance Test

10.5.1 Manner of appearance test

(1) The test must be under 20W*2 or 40W fluorescent light ,and the distance of view must be at 30 ± 5 cm.

(2) When test the model of Transmissive product must add the reflective plate.

(3) The test direction is base on about around 30 degree(within θ range) of vertical line.

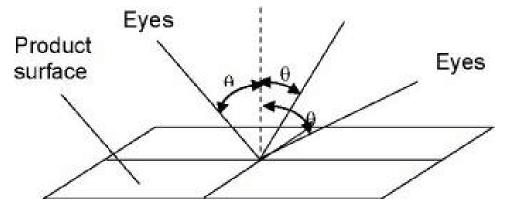
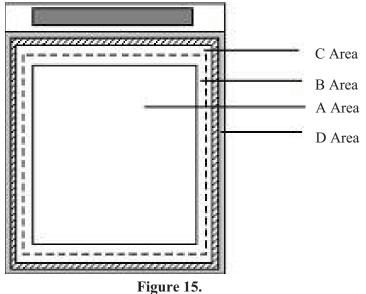


Figure 14.

- (4) Definition of Area:
 - A Area: Active area
 - B Area: Viewing area
 - C Area: Out of viewing area
 - D Area: Seal area



- 10.5.2 Basic principle:
- (1) It will accord to the AQL when the standard can not be described.
- (2) The sample of the lowest acceptable quality level must be discussed by both supplier and customer when any dispute happened.
- (3) Must add new item on time when it is necessary.

10.6 Inspection specification

NO	Item	Criterion				
01	Electrical Testing	 1.1 Missing vertical, horizontal segment, segment contrast defect. 1.2 Missing character, dot or icon. 1.3 Display malfunction. 1.4 No function or no display. 1.5 Current consumption exceeds product specifications. 1.6 LCD viewing angle defect. 1.7 Contrast defect 				
02	LCD black spots, white spots, color spots, contamination, scratches (display/non-displa y)	2.1Round type: As following drawing $\varphi = (x+y)/2$ $\downarrow \qquad \qquad$	1.5			

03	Polarizer bubbles Ignore	easy to find, must Size $\phi \leq 0.30$ $0.30 < \phi \leq 0.60$	check in spec	sing black spot specification cify direction. eptable QTY V. A Ignore 3 0	on, not 1.5
04	Chipped glass	Symbols: a: Chip length b: 0 t: Glass thickness 4.1 ITO electrode a<=t b==0.5mm c<=3.0mm *Effective width of seal ar 4.2 General ,corner a<=t b<=0.5mm c<=3.0mm *Effective width of seal ar	t t t t t t t t t t t t t t t t t t t	an 0.3mm.	1.5

05	Cracked glass	The LCD with extensive crack is not acceptable.			
		6.1 Illumination source flickers when lit.	0.65		
	Backlight elements	6.2 Spots or scratches that appear when lit must be judged	1.5		
06		using LCD spot, lines and contamination standards.			
		6.3 Backlight doesn't light or color is wrong			
			0.65		
		7.1 No unmelted solder paste may be present on the PCB.			
		7.2 No cold solder joints, missing solder connections, oxidation			
07	California a	or icicle.	1.5		
07	Soldering	7.3 No residue or solder balls on PCB.			
		7.4 No short circuits in components on PCB.	1.5		
			0.65		
		8.1 No oxidation, contamination, curves or, bends on interface	1.5		
		pin (OLB) of TCP.			
		8.2 No cracks on interface pin(OLB) of TCP	0.65		
		8.3 NO contamination, solder residue or solder balls on	1.5		
		product.			
	General appearance	8.4 The IC on the TCP may not be damaged, circuits.	0.65		
		8.5 The residual rosin or tin oil of soldering (component or chip	1.5		
		component) is not burned into brown or black color. 8.6			
		Sealant on top of the ITO circuit has not hardened	1.5		
08		8.7 Pin type must match type in specification sheet.	0.65		
00	Seneral appearance	8.8 LCD pin loose or missing pins.	0.65		
		8.9 Product packaging must the same as specified on packaging	0.65		
		specification sheet.			
		8.10 Product dimension and structure must conform to product	0.65		
		specification sheet.			

11 RELIABILITY

NO	Test Item	Description	Test Condition
1	High temperature storage	Endurance test applying the high storage temperature for a long time	80°С,240 Н
2	Low temperature storage	Endurance test applying the low storage temperature for a long time	-30℃,240H
3	High temperature operation	Endurance test applying the electric stress under high temperature for a long time	60℃,96H
4	Low temperature operation	Endurance test applying the electric stress under low temperature for a long time	-10℃,96H
5	High temperature /humidity storage	Endurance test applying the high temperature and high humidity storage for a long time	50℃,90% R.H 240H
6	High temperature /humidity operation	Endurance test applying electric stress under high temperature and high humidity for a long time	60℃, 90% R.H 96H
7	Temperature Cycle	Endurance test applying the low and high temperature cycle $-20^{\circ}C \rightarrow 25^{\circ}C \rightarrow 70^{\circ}C$ $\rightarrow 25^{\circ}C$ 30min 5min 30min 5min one cycle	-20°C/70°C 10 cycles
8	Vibration test	Endurance test applying the vibration during transportation and using	10Hz~50Hz Swing:0.75mm time:30min
9	Fall test	Endurance test dropping the LCM from a high place	600mm height
10	Static electricity test	Endurance test applying static electric stress to terminal	Contact discharge: ±2KV~4KV Air discharge: ±2KV~10KV

Table 8.

NOTE: TEST CONDITION

- (1) Temperature and humidity: If no specification, temp. set at $25\pm2^{\circ}$ C, humidity set at $60\pm5\%$ RH.
- (2) Operating state: Samples subject to the test shall be in "operating" condition.

12 USING LCD MODULES

12.1 LIQUID CRYSTAL DISPLAY MODULES

LCD is composed of glass and polarizer. Pay attention to the following items when handling.

- (1) Please keep the temperature within specified range for use and storage. Polarization degradation, bubble generation or polarizer peel-off may occur with high temperature and high humidity.
- (2) Do not touch, push or rub the exposed polarizers with anything harder than an HB pencil lead (glass, tweezers, etc.).
- (3) N-hexane is recommended for cleaning the adhesives used to attach front/rear polarizers and reflectors made of organic substances which will be damaged by chemicals such as acetone, toluene, ethanol and isopropylalcohol.
- (4) When the display surface becomes dusty, wipe gently with absorbent cotton or other soft material like chamois soaked in petroleum benzin. Do not scrub hard to avoid damaging the display surface.
- (5) Wipe off saliva or water drops immediately, contact with water over a long period of time may cause deformation or color fading.
- (6) Avoid contacting oil and fats.
- (7) Condensation on the surface and contact with terminals due to cold will damage, stain or dirty the polarizers. After products are tested at low temperature they must be warmed up in a container before coming is contacting with room temperature air.
- (8) Do not put or attach anything on the display area to avoid leaving marks on.
- (9) Do not touch the display with bare hands. This will stain the display area and degradate insulation between terminals (some cosmetics are determinated to the polarizers).
- (10) As glass is fragile. It tends to become or chipped during handling especially on the edges.Please avoid dropping or rising.

12.2 PRECAUTION FOR HANDING LCD MODULES

- Since LCM has been assembled and adjusted with a high degree of precision, avoid applying excessive shocks to the module or making any alterations or modifications to it.
- (1) Do not alter, modify or change the the shape of the tab on the metal frame.
- (2) Do not make extra holes on the printed circuit board, modify its shape or change the positions of components to be attached.
- (3) Do not damage or modify the pattern writing on the printed circuit board.
- (4) Absolutely do not modify the zebra rubber strip (conductive rubber) or heat seal connector.
- (5) Except for soldering the interface, do not make any alterations or modifications with a soldering

iron.

- (6) Do not drop, bend or twist LCM.
- (7) In order to avoid the cracking of the FPC, you should to pay attention to the area of FPC(R50mm) where the FPC was bent .the edge of coverlay; the area of surface of Ni-Au plating, the area of soldering land, the area of through hole.

12.3 ELECTRO-STATIC DISCHARGE CONTROL

Since this module uses a CMOS LSI, the same careful attention should be paid to electrostatic discharge as for an ordinary CMOS IC.

- (1) Make certain that you are grounded when handing LCM.
- (2) Before remove LCM from its packing case or incorporating it into a set, be sure the module and your body have the same electric potential.
- (3) When soldering the terminal of LCM, make certain the AC power source for the soldering iron does not leak.
- (4) When using an electric screwdriver to attach LCM, the screwdriver should be of ground potentiality to minimize as much as possible any transmission of electromagnetic waves produced sparks coming from the commutator of the motor.
- (5) As far as possible make the electric potential of your work clothes and that of the work bench the ground potential.
- (6) To reduce the generation of static electricity be careful that the air in the work is not too dried. A relative humidity of 0%-60% is recommended.

12.4 PRECAUTIONS FOR OPERATION

- (1) Viewing angle varies with the change of liquid crystal driving voltage (VO). Adjust VO to show the best contrast.
- (2) Driving the LCD in the voltage above the limit shortens its life.
- (3) Response time is greatly delayed at temperature below the operating temperature range. However, this does not mean the LCD will be out of the order. It will recover when it returns to the specified temperature range.
- (4) If the display area is pushed hard during operation, the display will become abnormal. However, it will return to normal if it is turned off and then back on.
- (5) Condensation on terminals can cause an electrochemical reaction disrupting the terminal circuit. Therefore, it must be used under the relative condition of 40°C, 50% RH.
- (6) When turning the power on, input each signal after the positive/negative voltage becomes stable.

ATM0350D2(AZ DISPLAYS) TFT MODULE VER2.2

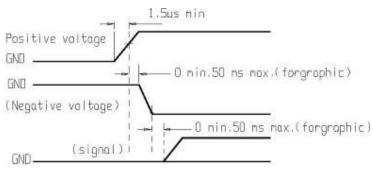


Figure 16.

12.5 STORAGE

When storing LCDs as spares for some years, the following precaution are necessary.

- (1) Store them in a sealed polyethylene bag. If properly sealed, there is no need for dessicant.
- (2) Store them in a dark place. Do not expose to sunlight or fluorescent light, keep the temperature between 0°C and 35°C.
- (3) The polarizer surface should not come in contact with any other objects. (We advise you to store them in the container in which they were shipped.)
- (4) Environmental conditions :
- Do not leave them for more than 160hrs. at 70°C.
- Should not be left for more than 48hrs. at -20°C.

12.6 SAFETY

- (1) It is recommended to crush damaged or unnecessary LCDs into pieces and wash them off with solvents such as acetone and ethanol, which should later be burned.
- (2) If any liquid leakes out of a damaged glass cell and comes in contact with the hands, wash off thoroughly with soap and ater.

12.7 LIMITED WARRANTY

Unless agreed between AZD and customer, AZD will replace or repair any of its LCD modules which are found to be functionally defective when inspected in accordance with AZD LCD modules acceptance standards (copies available upon request) for a period of one year from date of shipments. Cosmetic/visual defects must be returned to AZD within 90 days of shipment. Confirmation of such date shall be based on freight documents. The warranty liability of AZD limited to repair and/or replacement on the terms set forth above. AZD will not be responsible for any subsequent or consequential events.

12.8 RETURN LCM UNDER WARRANTY

No warranty can be granted if the precautions stated above have been disregarded. The typical examples of violations are :

- Broken LCD glass.
- Circuit modified in any way, including addition of components.

Module repairs will be invoiced to the customer upon mutual agreement. Modules must be returned with sufficient description of the failures or defects. Any connectors or cable installed by the customer must be removed completely without damaging the PCB's eyelet, conductors and terminals.